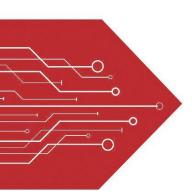
MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

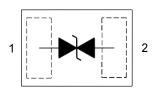
Broduct data speet



Features

- ♦ low Capacitance 10pF
- ◆ Low Clamping Voltage
- ◆ Small Body Outline Dimensions: 0.039" x 0.024" (1.0 mm x0.60 mm)
- ◆ Low Body Height: 0.019" (0.5 mm)
- ◆ Stand-off Voltage: 3.3V
- ♦ Low Leakage
- ♦ Response Time is Typically < 1 ns
- ♦ IEC61000-4-2 Level 4 ESD Protection for data lines
- ♦ These are Pb-Free Devices





SOD-882

Applications

- ◆ 10/100/Mbits/s Ethernet
- ◆ FireWire
- Display ports
- ♦ MDDI ports
- ◆ Digital Visual Interface (DVI)
- ◆ Cellular handsets & accessories
- Computer and peripherals

Maximum Rating @ Ta=25°C unless otherwise specified

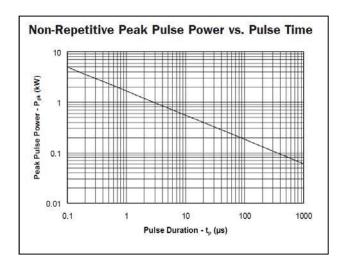
Symbol	Parameter	Ratings	Units	
ESD	IEC 61000-4-2 (HBM-ESD)	Contact	8	KV
		Air	15	N.V.
TL	Lead Soldering Temperature	260(10sec.)	${\mathbb C}$	
TJ	Operating Temperature	-55 to +125	${\mathbb C}$	
T _{STG}	Storage Temperature	-55 to +150	$^{\circ}$	

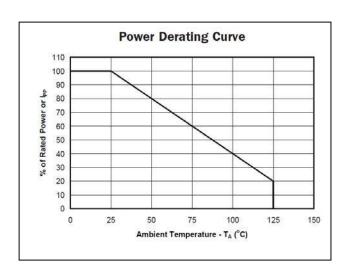


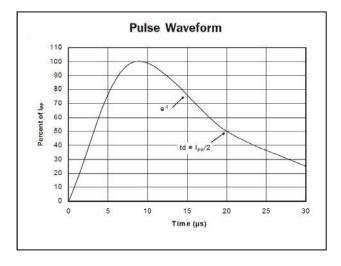
Electrical Characteristics@ Ta=25°C unless otherwise

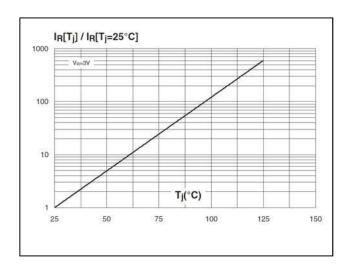
		VRWM@IR		VBR@ImA	VC@1A	VC@IPP		Cl
	Parameter	V	μA	V	V	V	Α	pF
			MAX	MIN	MAX	MAX		TYP
	XESD2FD3V3B	3.3	1	5.0	7	10	5	15

Typical Characteristics@ Ta=25°C unless otherwise specified



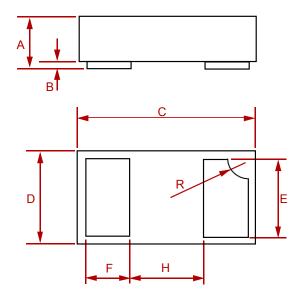






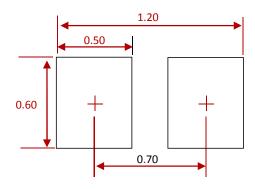


PACKAGE MECHANICAL DATA



Dim	Inches		Millimeters		
Dim	MIN	MAX	MIN	MAX	
Α	0.0125	0.02	0.32	0.52	
В	0.000	0.002	0.00	0.05	
С	0.037	0.043	0.95	1.080	
D	0.022	0.027	0.55	0.680	
Е	0.016	0.024	0.40	0.60	
F	0.008	0.012	0.20	0.30	
Н	0.015Typ.		0.40Typ.		
R	0.001	0.005	0.05	0.15	

Suggested Pad Layout



NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

REEL SPECIFICATION

P/N	PKG	QTY
XESD2FD3V3B	SOD-882	10000



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